

White Heat Transfer Compound

Model: HC-131



Features:

- Thermal Conductivity of the grease reaches 0.8-1.8W/MK.
- Fewer than 300 °C temperature conditions is non-Harding, no flow, good temperature persistence.
- Thermal paste is fully in line with the targets of the international SGS requirements.

Specification:

Thermal Conductivity	>0.965
Thermal Impedance	<0.225
Specific Gravity	>2.3
Evaporation	< 0.001
Bleed	< 0.05
Moment bearded temperature	-50~240°C
Operation Temperature	-30~180°C
Weight	10g
Color	White

Effectiveness and USE:

1. Used as a heat transfer medium of electronic components this can enhance the efficiency of the heat conduction.
2. For the better heat conduction between CPU and heat sink and belong the life of CPU.
3. Filling in gaps when High-power transistors connect with aluminum, copper accessory.
4. Reduce the operate Heat of various of Thermal Dissipation elements to guarantee their Normal operation.

This product's storage period is 1 year (25 °C below).

These products are non-dangerous goods, according to general chemical transport.

Introduction of Thermal paste:

Thermal pastes Mainly used for Computer CPU, Heat sink, and Electronic and Electrical Appliances Such as Electric Stove, Refrigerator, Water Dispenser, Electric Kettle, etc.), Electrical (switching Power Supply, Relay, Inverter, Thermistor, etc.), Control board, Graphics Card, LCD , Fiber-optic Communications Equipment, LED and other Wide Range of Electrical and Electronic Fields.